## Government ePublishing System

## ePublishing System, Government of India

## **Tender Details**

Date: 11-Jun-2021 04:13 PM



Basic Details						
Organisation Chain	Indian Institute of Techr	Indian Institute of Technology Madras  Deputy Registrar (Industrial Consultancy and Sponsored Research)				
Tender Reference Number	EE/BIJOY/008/2021/PHOTONIC CHIP					
Tender ID	2021_IIT-M_608940_1					
Tender Type	Open Tender	Form of contract	Supply			
Tender Category	Goods	No. of Covers	4			
Payment Mode	Not Applicable	Is Multi Currency Allowed For BOQ	No			
Is Multi Currency Allowed For Fee	No					

Cover Details, No. Of Covers - 4					
Cover No	Cover	Document Type	Description		
1	Fee	.pdf	The Exemption Certificate / Declaration should be enclosed in Technical Bid Cover Only		
2	PreQual	.pdf	Pre-qualification bid		
3	Technical	.pdf	Technical bid		
4	Finance	.xls	Financial bid		

Tender Fee Details, [Total Fee in ₹ * - 0.00]			EMD Fee Details				
Tender Fee in ₹	0.00			EMD Amount in ₹	0.00	EMD Exemption	NA
Fee Payable To	NA	Fee Payable At	NA			Allowed	
Tender Fee	NA			EMD Fee Type	NA	EMD Percentage	NA
<b>Exemption Allowed</b>	_ I			EMD Payable To	NA	EMD Payable At	NA

Work /Item(s)							
Title	SILICON PHOTONI	SILICON PHOTONIC CHIP TAPE OUT IN SILICON ON INSULATOR PLATFORM					
Work Description	SILICON PHOTONI	C CHIP TAPE OUT IN SILICO	N ON INSULATO	OR PLATFORM			
Pre Qualification Details	Please refer Tende	r documents.					
Tender Value in ₹		Product Category	Miscellaneous Goods	Sub category	NA		
Contract Type	Tender	Bid Validity(Days)	90	Period Of Work(Days)	21		
Location	Department of Electrical Engineering	Pincode	600036	Pre Bid Meeting Place	NA		
Pre Bid Meeting Address	NA	Pre Bid Meeting Date	NA	Bid Opening Place	Department of Electrical Engineering		

<u>Critical Dates</u>			
Publish Date	11-Jun-2021 04:25 PM	Bid Opening Date	02-Jul-2021 03:00 PM
Document Download / Sale Start Date	11-Jun-2021 04:35 PM	Document Download / Sale End Date	01-Jul-2021 05:00 PM
Clarification Start Date	NA	Clarification End Date	NA
Bid Submission Start Date	14-Jun-2021 09:00 AM	Bid Submission End Date	01-Jul-2021 05:00 PM

<u>Tender Documents</u>							
NIT Document	S.No	Document Name	Description	Document Size (in KB)			
	1	Tendernotice_1.pdf	AS PER THE TENDER DOCUMENT	446.62			
Work Item							

	Documents	S.No	Document Type	<b>Document Name</b>	Description	Document Size (in KB)
		1	Additional Documents	ANNEXURE - IV.pdf	ANNEXURE - IV	634.38
		2	Tender Documents	OPEN TENDER - SILICON PHOTONIC CHIP TAPE.pdf	OPEN TENDER	446.62
1						

<u>Tender Inviting Authority</u>		
Name	The Senior Manager	
	The Senior Manager, Project Purchase, I.I.T. Madras, Sardar Patel Road, ICSR Building, 2nd floor, Chennai - 600 036	

Tender Creator I	Tender Creator Details			
Created By	Vijay Shankar B			
Designation	Assistant Registrar			
Created Date	11-Jun-2021 04:09 PM			